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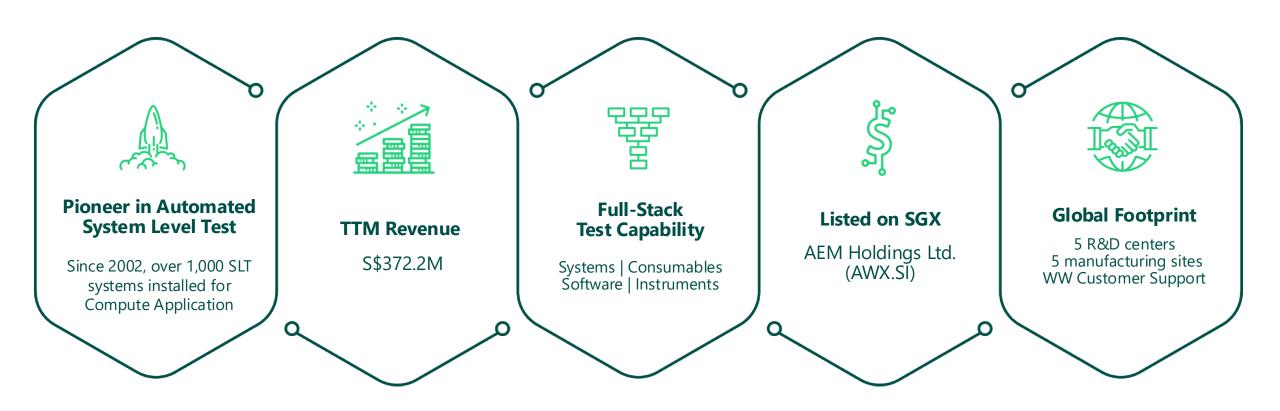
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In this presentation, all \$ dollar amounts are in Singapore dollars unless otherwise specified.



AEM Corporate Profile

AEM is a global leader in application-specific test and handling solutions for semiconductor and electronics companies serving the Compute and Advanced Packaging markets





1Q2025 Highlights

As expected, sequential decline due to customer pull-in to 4Q2024 from FY2025; TCS new customer revenue doubled vs. 4Q2024

Revenue

S\$86.0M

-35% vs 4Q2024

PBT (excluding exceptional items)

\$3.8M

-71% vs 4Q2024 -5.6pts vs 4Q2024

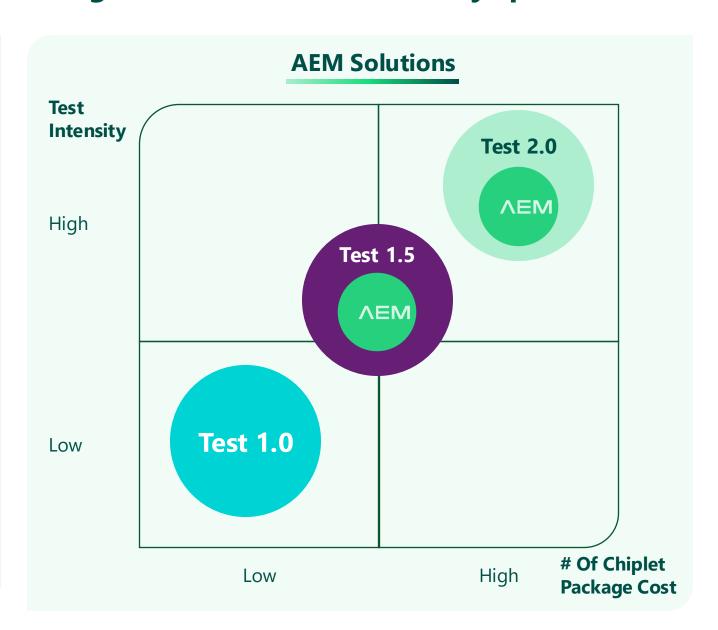


Recognized as **Technology Leader in Thermal Management** as AMPS-BI shifts into production test with a major **new AI/HPC anchor customer**



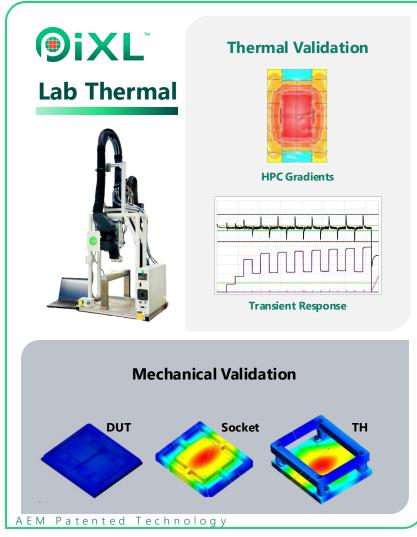
AEM's solutions address test challenges across the test intensity spectrum

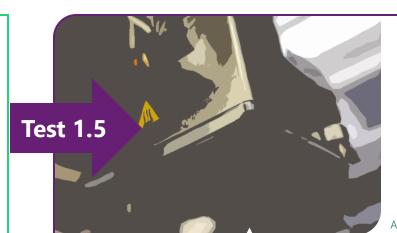
Chiplet Test Challenges Higher Device Power Thermal Management Increased Test Time Complex Test Coverage





Broad product portfolio supports customer journey from lab to HVM*







Generic Final Test Handlers Generic SLT Handlers Generic Burn-in Chambers

AEM Patented Technology

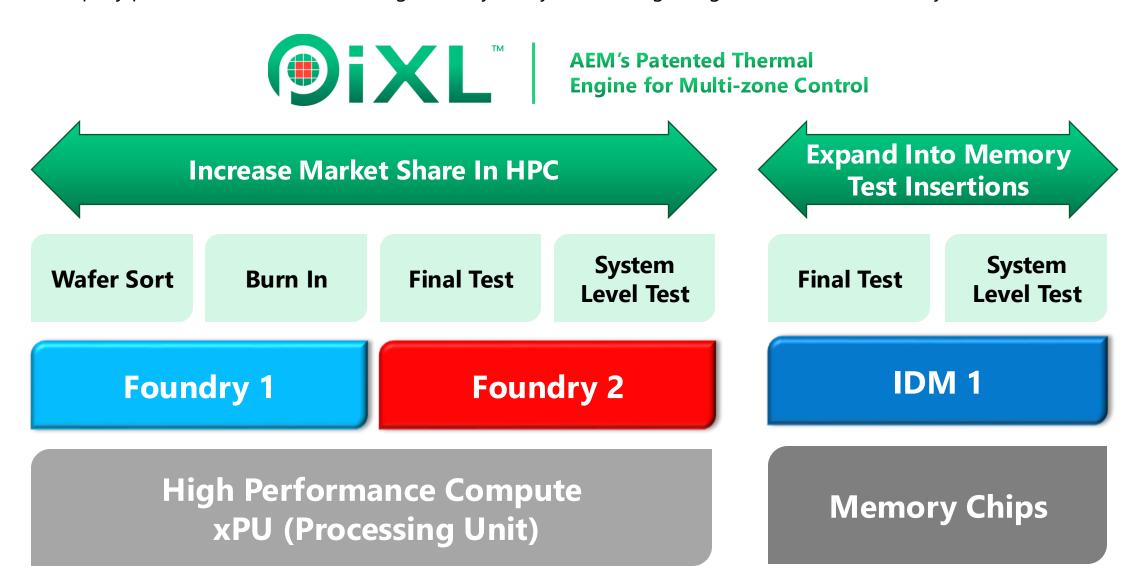


^{*} HVM: High Volume Manufacturing



AEM's "Follow the Chiplet" growth strategy resulting in account wins

Uniquely positioned inside two leading Foundry ecosystems and gaining traction in the Memory market





Customer diversification journey is driven by R&D investments

R&D Expenses

FY2024 **S\$23.7M**

Socket Technology

Wafer Probe Machine Vision

Thermal Software

Control Instrumentation

Advanced Automation

15 PatentsAs of FY2024

Increase Engagements

Memory

1 Large memory IDM for SLT, FT

xPU

2 HPC / Al customers for Al Burn-In and HPC SLT

Systems / Hyperscalers

2 Application Processor customers for SLT

Production

Early production SLT test for GDDRx in 2025

Customer 1

Early production test in 2025

Customer 2

Mid-volume production in 2025



1Q2025 Financial Highlights

As expected, sequential decline due to customer pull-in to 4Q2024 from FY2025; TCS new customer revenue doubled vs. 4Q2024



PBT (excluding exceptional items)

\$\$3.8M 4.4% of Revenue

-71% vs 4Q2024 -5.6pts vs 4Q2024

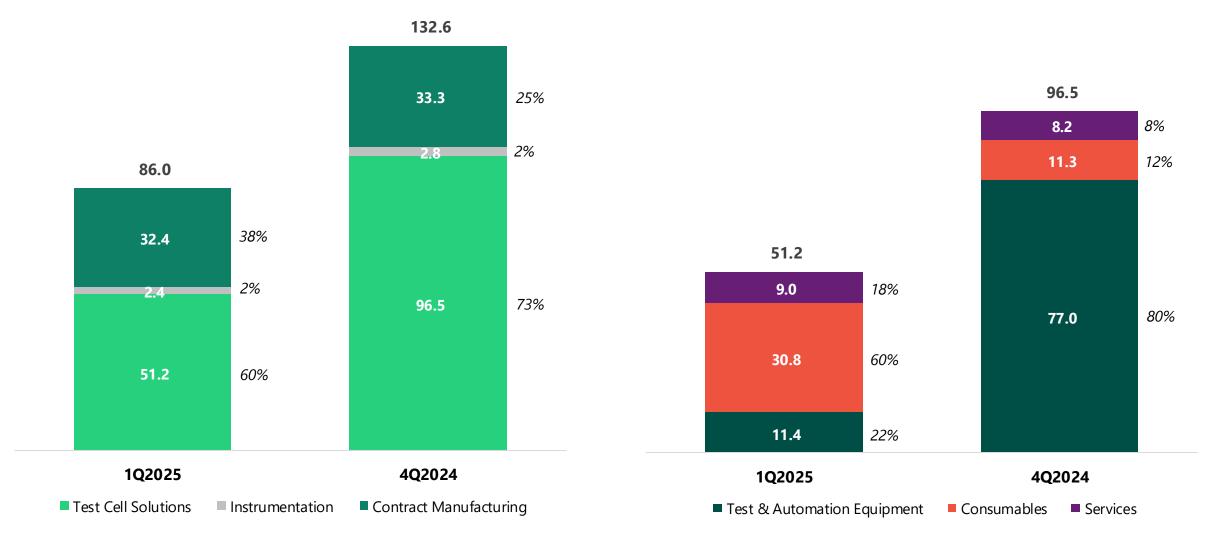


Revenue Mix: 1Q2025 vs 4Q2024

TCS revenue came in at S\$51M, contributing to 60% of revenue in 1Q2025

Total Revenue Mix (S\$M)

Test Cell Solutions Revenue Mix (S\$M)





Balance Sheet

A robust balance sheet with Debt/Equity at 0.1X

- As at end-March 2025, net assets were valued at S\$492.4 million, up S\$0.1 million from end-Dec 2024
- NAV per share remained at 155 cents
- Inventories, which are predominantly related to the Group's non-cancellable long-dated purchase order program with its key customer, declined 5.3% to \$\$281.1 million
- Financial liabilities decreased by 23.1% to S\$72.5 million due to the repayment of debt, further reducing the Group's debt-to-equity ratio to 0.1x

	As at		
	Mar'25	Dec'24	Change
	S\$M	S\$M	%
Cash	42.2	43.8	(3.5)
Inventories	281.1	296.8	(5.3)
Financial liabilities	72.5	94.4	(23.1)
Net assets	492.4	492.3	0.0
in SG cents			
NAV per share	155	155	0.0
Debt / Equity	0.1X	0.2X	-



Investment Highlights

- Serving a large and high-growth Advanced Package burn-in and system level test market
- Emerging growth and customer diversification in TCS business
- Differentiated products to address increasingly complex test requirements for AI/HPC devices
- Diversified vertical markets through Contract Manufacturing business





Thank You

Investor Relations Contact

Samir MOWLA samir.mowla@aem.com.sg

Financial PR Pte Ltd

Kamal SAMUEL / Shivam SARAF Tel: 6438 2990 / Fax: 6438 0064 kamal@financialpr.com.sg shivam@financialpr.com.sg